

C0402C182F4TACTU

Aliases (C0402C182F4TAC7867) SMD Comm X8G HT150C, Ceramic, 1,800 pF, 1%, 16 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
Т	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm

Packaging Specifications	
В	0.3mm +/-0.1mm
S	0.3mm MIN
Т	0.5mm +/-0.05mm
W	0.5mm +/-0.05mm

10000

Packaging

Packaging Quantity

	Specifications	
	Capacitance	1,800 pF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	1%
	Voltage DC	16 VDC
	Dielectric Withstanding Voltage	40 VDC
	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
	Insulation Resistance	100 GOhms

Dissipation Factor	U.1% 1 KF
Aging Rate	0% Loss Time is
Insulation Resistance	100 GO
,	Aging Rate

T&R, 180mm, Paper Tape

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